



## ULTRA-SMALL SUPPLY VOLTAGE SUPERVISORS

Check for Samples: [TPS3800-xx](#), [TPS3801-xx](#), [TPS3802-xx](#)

### FEATURES

- Small, 5-Pin SC-70 (SOT-323) Package
- Supply Current of 9  $\mu$ A
- Power-On Reset Generator With Fixed Delay Time
  - TPS3800 = 100 ms
  - TPS3801 = 200 ms
  - TPS3802 = 400 ms
- Precision Supply Voltage Monitor 1.8 V, 2.5 V, 2.7 V, 3 V, 3.3 V, 5 V, and Adjustable
- Manual Reset Input (Except TPS3801-01)
- Temperature Range:  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$

### APPLICATIONS

- Applications Using DSPs, Microcontrollers, or Microprocessors
- Wireless Communication Systems
- Portable/Battery-Powered Equipment
- Programmable Controls
- Intelligent Instruments
- Industrial Equipment
- Notebook/Desktop Computers
- Automotive Systems

### DESCRIPTION

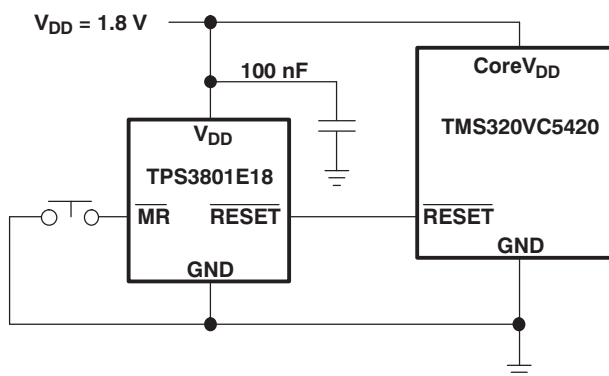
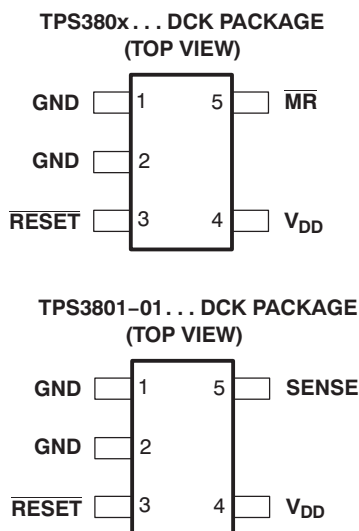
The TPS380x family of supervisory circuits monitor supply voltages to provide circuit initialization and timing supervision, primarily for DSPs and other processor-based systems.

These devices assert a push-pull  $\overline{\text{RESET}}$  signal when the SENSE (adjustable version) or  $V_{\text{DD}}$  (fixed version) drops below a preset threshold. The  $\overline{\text{RESET}}$  output remains asserted for the factory programmed delay time after the SENSE or  $V_{\text{DD}}$  return above its threshold.

The TPS380x devices, except the TPS3801-01, incorporate a manual reset input ( $\overline{\text{MR}}$ ). A low level at  $\overline{\text{MR}}$  causes  $\overline{\text{RESET}}$  to become active.

The TPS380x uses a precision reference to achieve an overall threshold accuracy of 2%–2.5%. These devices are available in a 5-pin SC-70 package, which is only about half the size of a 5-pin SOT-23 package.

The TPS380x devices are fully specified over a temperature range of  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### AVAILABLE OPTIONS<sup>(1)</sup>

T <sub>A</sub>	DEVICE NAME	THRESHOLD VOLTAGE	TYP DELAY TIME	MARKING
–40°C to 85°C	TPS3801-01DCK	Adjustable (V <sub>ref</sub> = 1.14 V)	200 ms	ARF
	TPS3801E18DCK	1.71 V	200 ms	ARE
	TPS3801J25DCK	2.25 V	200 ms	NJA
	TPS3800G27DCK	2.5 V	95 ms	ARI
	TPS3801L30DCK	2.64 V	200 ms	NPA
	TPS3801K33DCK	2.93 V	200 ms	NWA
	TPS3802L30DCK	2.64 V	380 ms	ASA
	TPS3802K33DCK	2.93 V	380 ms	ARK
	TPS3801T50DCK	4.00 V	25 ms	AVI
	TPS3801I50DCK	4.55 V	200 ms	NSA

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this data sheet, or refer to our web site at [www.ti.com](http://www.ti.com).

### ABSOLUTE MAXIMUM RATINGS<sup>(1) (2)</sup>

Over operating free-air temperature range (unless otherwise noted).

	UNIT
Supply voltage, V <sub>DD</sub>	7 V
SENSE	–0.3 V to 5 V
All other pins	–0.3 V to 7 V
$\overline{\text{MR}}$	–0.3 V to V <sub>DD</sub> + 0.3 V
$\overline{\text{RESET}}$	–0.3 V to V <sub>DD</sub> + 0.3 V
Maximum low-output current, I <sub>OL</sub>	5 mA
Maximum high-output current, I <sub>OH</sub>	–5 mA
Input-clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>DD</sub> )	±20 mA
Output-clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>DD</sub> )	±20 mA
Operating junction temperature range, T <sub>J</sub> <sup>(3)</sup>	–40°C to +85°C
Storage temperature range, T <sub>stg</sub>	–65°C to +150°C

(1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values are with respect to GND. For reliable operation, the device should not be operated at 7 V for more than t = 1000h continuously.

(3) Due to the low dissipation power of this device, it is assumed that T<sub>J</sub> = T<sub>A</sub>.

### RECOMMENDED OPERATING CONDITIONS

	MIN	MAX	UNIT
Supply voltage, V <sub>DD</sub>	TPS3801J25, TPS3801L30, TPS3801K33, TPS3801I50, TPS3801T50	2	6
	All other devices	1.6	4
SENSE	0	See <sup>(1)</sup>	V
Input voltage, V <sub>I</sub>	0	V <sub>DD</sub> + 0.3	V
High-level input voltage, V <sub>IH</sub>	0.7 × V <sub>DD</sub>	V <sub>DD</sub> + 0.3	V
Low-level input voltage, V <sub>IL</sub>		0.3 × V <sub>DD</sub>	V
Input transition rise and fall rate at $\overline{\text{MR}}$ , Δt/ΔV		100	ns/V
Pull-up resistor value, $\overline{\text{RESET}}$	V <sub>Pull-up</sub> 50μA		Ω
Operating free-air temperature range, T <sub>A</sub>	–40	+85	°C

(1) Maximum = V<sub>DD</sub> + 0.3 or 4.5 V, whichever is greater.

## ELECTRICAL CHARACTERISTICS

Over –40°C to +85°C free-air temperature range (unless otherwise noted).

PARAMETER		TEST CONDITIONS	TPS3800-xx, TPS3801-xx, TPS3802-xx			UNIT	
			MIN	TYP	MAX		
V <sub>OH</sub>	High-level output voltage ( $\overline{\text{RESET}}$ )	V <sub>DD</sub> = 1.6 V to 6 V I <sub>OH</sub> = –500 μA	V <sub>DD</sub> –0.2			V	
		V <sub>DD</sub> = 3.3 V I <sub>OH</sub> = –2 mA	V <sub>DD</sub> –0.4				
		V <sub>DD</sub> = 6 V I <sub>OH</sub> = –4 mA <sup>(1)</sup>	V <sub>DD</sub> –0.4				
V <sub>OL</sub>	Low-level output voltage ( $\overline{\text{RESET}}$ )	V <sub>DD</sub> = 1.6 V to 6 V, I <sub>OL</sub> = 500 μA	0.2			V	
		V <sub>DD</sub> = 3.3 V, I <sub>OL</sub> = 2 mA	0.4				
		V <sub>DD</sub> = 6 V, I <sub>OL</sub> = 4 mA <sup>(1)</sup>	0.4				
Power-up reset voltage <sup>(2)</sup>		V <sub>DD</sub> ≥ 1.1 V, I <sub>OL</sub> = 50 μA	0.2			V	
V <sub>IT–</sub>	Negative-going input threshold voltage <sup>(3)</sup>	T <sub>A</sub> = –40°C to 85°C	TPS380x-01	1.117	1.14	1.163	V
			TPS380xE18	1.67	1.71	1.75	
			TPS380xJ25	2.2	2.25	2.3	
			TPS380xG27	2.45	2.5	2.55	
			TPS380xL30	2.58	2.64	2.7	
			TPS380xK33	2.87	2.93	2.99	
			TPS380xI50	4.45	4.55	4.65	
			TPS380xT50	3.92	4	4.08	
V <sub>hys</sub>	Threshold hysteresis		TPS380x-01	15			mV
			TPS380xx18	25			
			TPS380xx25	30			
			TPS380xx27	35			
			TPS380xx30	35			
			TPS380xx33	40			
			TPS380xx50	60			
I <sub>IH</sub>	High-level input current ( $\overline{\text{MR}}$ )	$\overline{\text{MR}}$ = 0.7×V <sub>DD</sub> , V <sub>DD</sub> = 6 V	–40	–60	–100	μA	
I <sub>IL</sub>	Low-level input current ( $\overline{\text{MR}}$ )	$\overline{\text{MR}}$ = 0 V, V <sub>DD</sub> = 6 V	–130	–200	–340		
I <sub>I</sub>	Input current (SENSE)		–25		25	nA	
I <sub>DD</sub>	Supply current	TPS3801J25, TPS3801L30, TPS3801K33, TPS3801I50, TPS3801T50	V <sub>DD</sub> = 2 V, $\overline{\text{MR}}$ and output unconnected	9	12	μA	
			V <sub>DD</sub> = 6 V, $\overline{\text{MR}}$ and output unconnected	20	25		
		TPS3801-01	V <sub>DD</sub> = 1.6 V, SENSE = 0 V to V <sub>DD</sub> , output unconnected	7	10		
			V <sub>DD</sub> = 4 V, SENSE = 0 V to V <sub>DD</sub> , output unconnected	9	12		
		TPS3801E18, TPS3800G27, TPS3802K33, TPS3802L30	V <sub>DD</sub> = 1.6 V, $\overline{\text{MR}}$ and output unconnected	8	11		
			V <sub>DD</sub> = 4 V, $\overline{\text{MR}}$ and output unconnected	13	18		
C <sub>i</sub>	Input capacitance	V <sub>I</sub> = 0 V to V <sub>DD</sub>	5			pF	

(1) Only valid for the TPS3801J25, TPS3801L30, TPS3801K33, TPS3801I50, and TPS3801T50.

(2) The lowest supply voltage at which  $\overline{\text{RESET}}$  becomes active. t<sub>r</sub>, V<sub>DD</sub>  $\geq$  15  $\mu$ s/V.

(3) To ensure the best stability of the threshold voltage, a bypass capacitor (0.1- $\mu$ F ceramic) should be placed near the supply terminals.

## TIMING REQUIREMENTS

at  $R_L = 1\text{ M}\Omega$ ,  $C_L = 50\text{ pF}$ ,  $T_A = +25^\circ\text{C}$

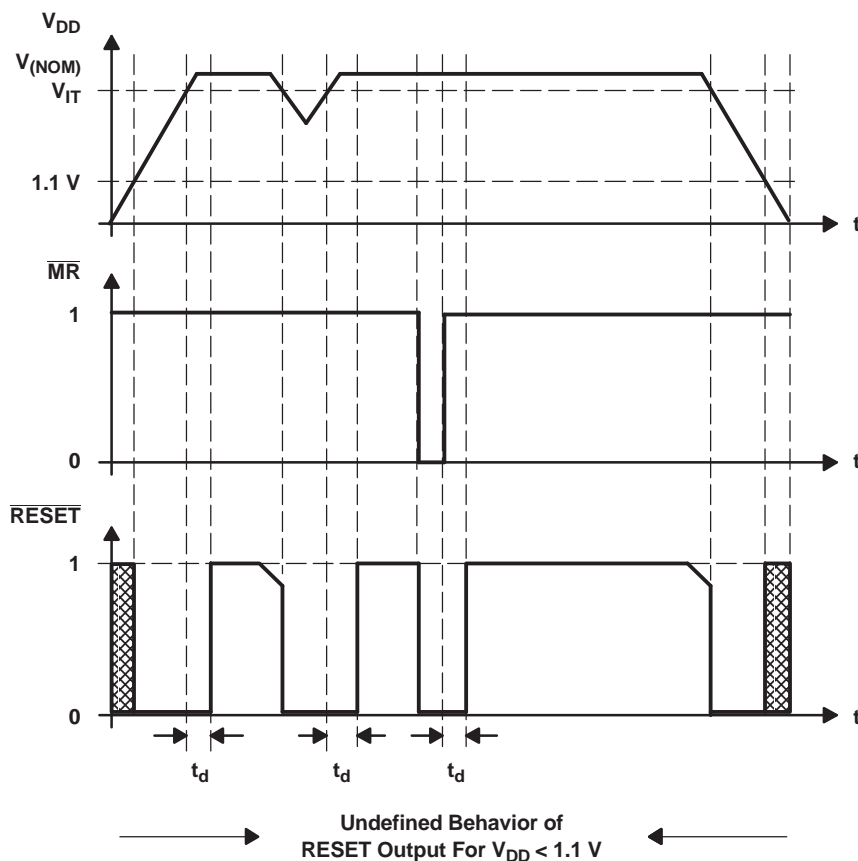
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_w$ Pulse width	at SENSE	$V_{DD} = 1.6\text{ V}$ , $V_{IH} = 1.1 \times V_{IT-}$ , $V_{IL} = 0.9 \times V_{IT-}$	1			$\mu\text{s}$
	at $V_{DD}$	$V_{DD} = V_{IT-} + 0.2\text{ V}$ , $V_{DD} = V_{IT-} - 0.2\text{ V}$	3			
	at $\overline{\text{MR}}$	$V_{DD} \geq V_{IT-} + 0.2\text{ V}$ , $V_{IL} = 0.3 \times V_{DD}$ , $V_{IH} = 0.7 \times V_{DD}$	100			ns

## SWITCHING CHARACTERISTICS

at  $R_L = 1\text{ M}\Omega$ ,  $C_L = 50\text{ pF}$ ,  $T_A = +25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_d$ $\overline{\text{RESET}}$ recovery delay time	TPS3801T50	$V_{DD} \geq V_{IT-} + 0.2\text{ V}$ , $\overline{\text{MR}} \geq 0.7 \times V_{DD}$ See <a href="#">timing diagram</a>	15	25	35	ms
	TPS3800		60	95	140	
	TPS3801		120	200	280	
	TPS3802		240	380	560	
$t_{PHL}$ Propagation (delay) time, high-to-low-level output	$\overline{\text{MR}}$ to $\overline{\text{RESET}}$ delay	$V_{DD} \geq V_{IT-} + 0.2\text{ V}$ , $V_{IL} = 0.3 \times V_{DD}$ , $V_{IH} = 0.7 \times V_{DD}$		15		ns
	$V_{DD}$ to $\overline{\text{RESET}}$ delay	$V_{IL} = V_{IT-} - 0.2\text{ V}$ , $V_{IH} = V_{IT-} + 0.2\text{ V}$		1		$\mu\text{s}$
	SENSE to $\overline{\text{RESET}}$					

## TIMING DIAGRAM



NOTE:  $\overline{\text{RESET}}$  should not be forced high during the power-up sequence (until  $V_{DD} > 1.1\text{ V}$ ).

## FUNCTIONAL BLOCK DIAGRAMS

FUNCTION/TRUTH TABLE, TPS380x

MR	$V_{DD} > V_{IT}$	RESET
L	0	L
L	1	L
H	0	L
H	1	H

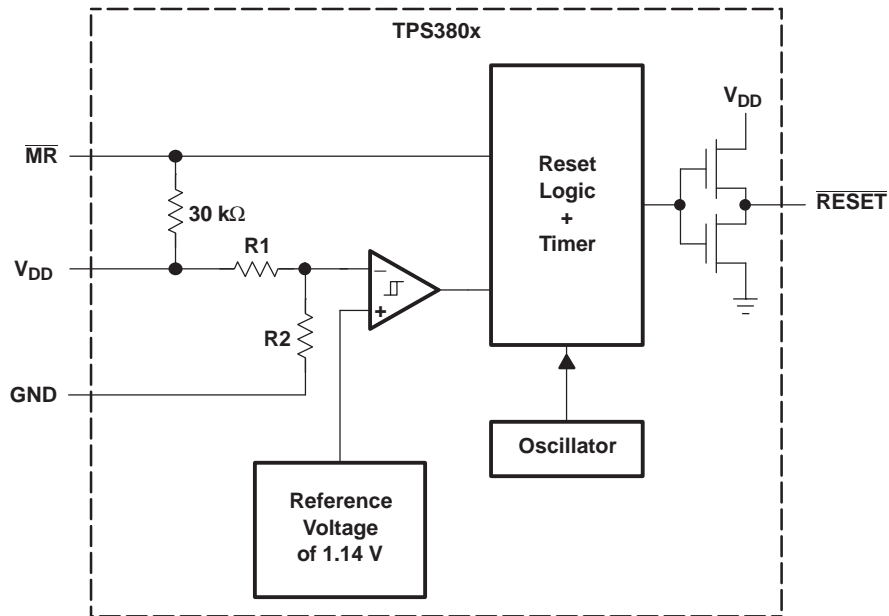


Figure 1.

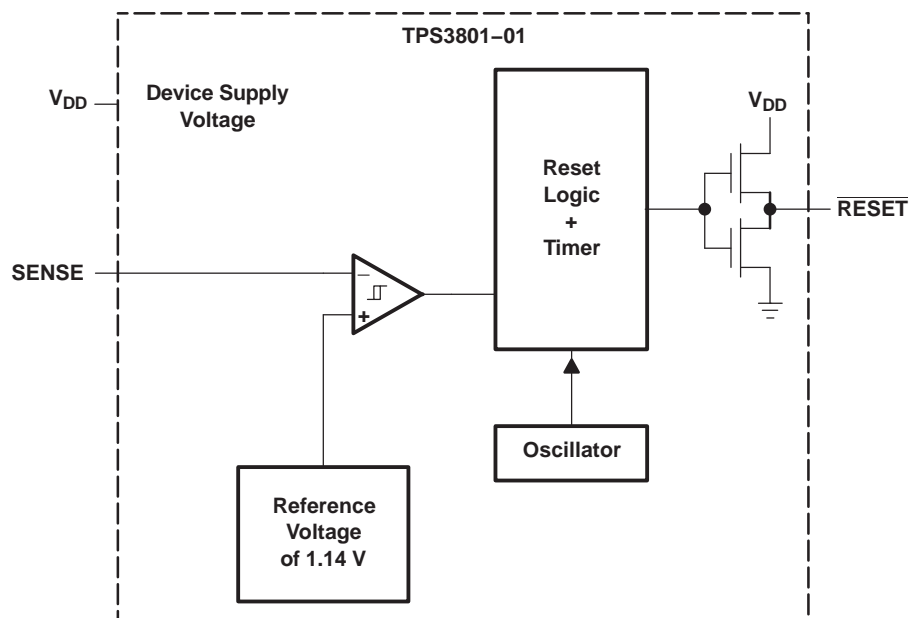


Figure 2.

## TYPICAL CHARACTERISTICS

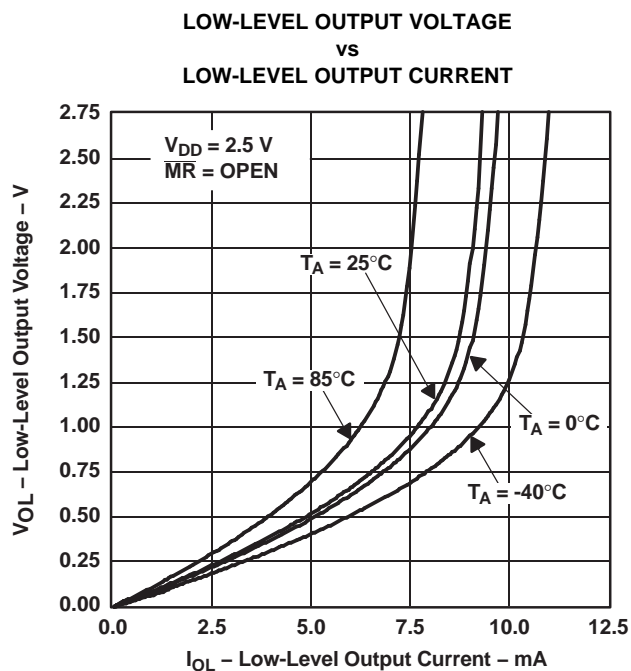


Figure 3.

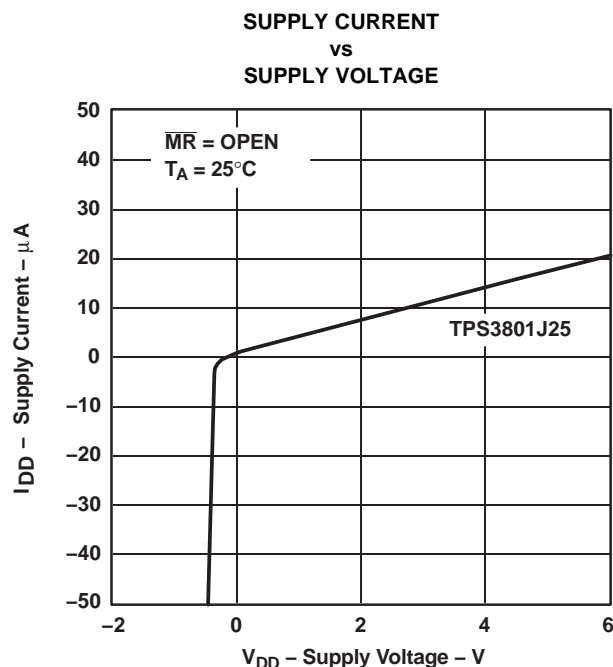


Figure 4.

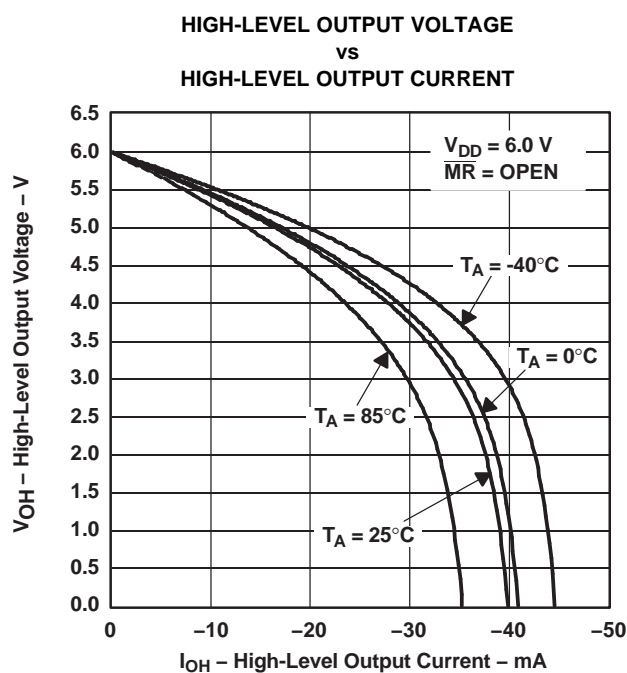


Figure 5.

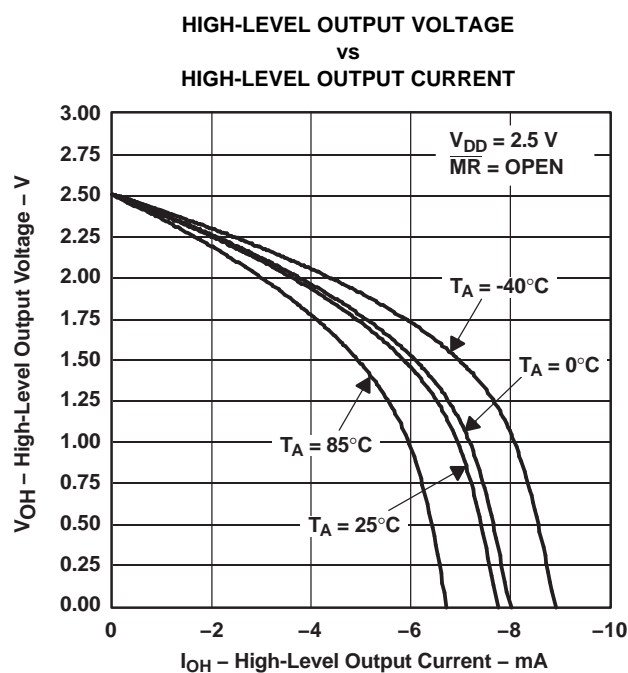


Figure 6.

## TYPICAL CHARACTERISTICS (continued)

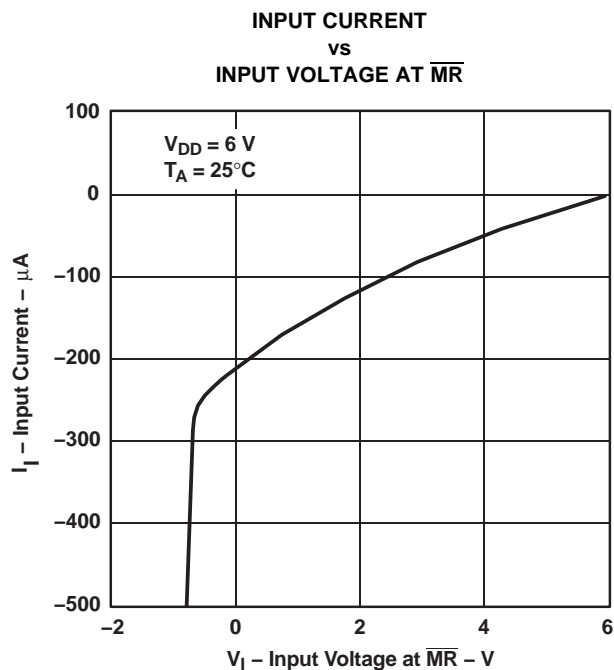


Figure 7.

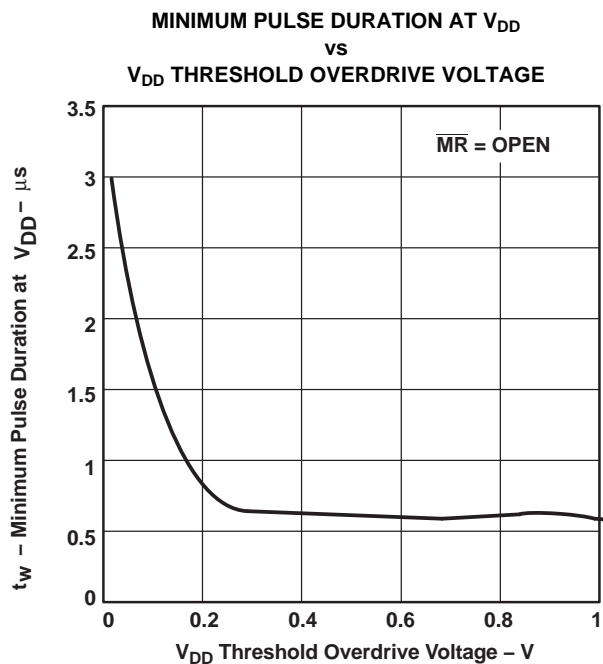


Figure 8.

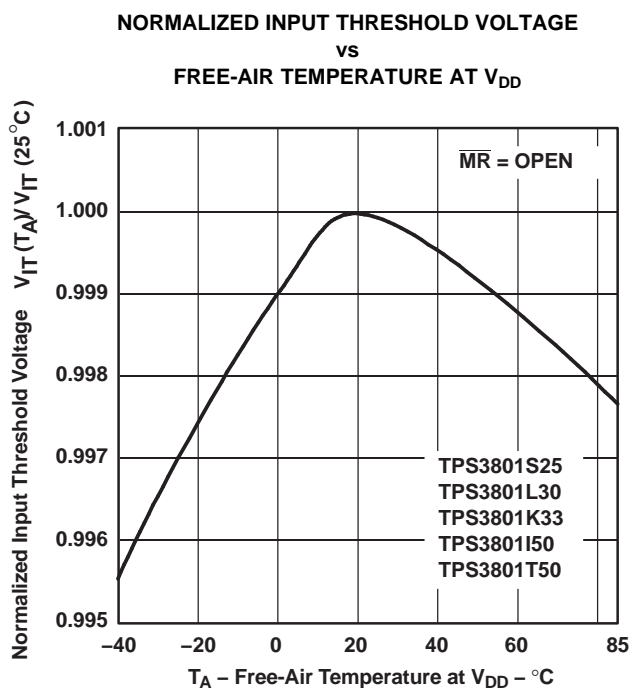


Figure 9.

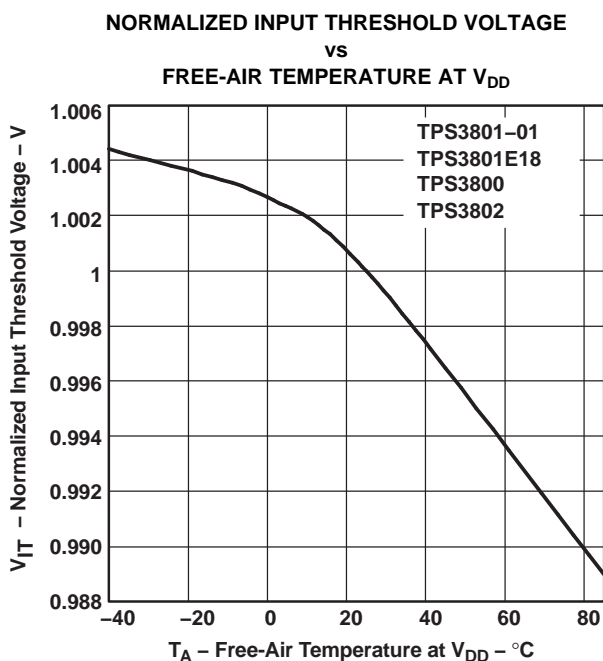


Figure 10.

---

Changes from Revision D (December 2006) to Revision E

Page

- 
- Added Pull-up resistor value,  $\overline{\text{RESET}}$  to the Recommended Operating Conditions Table ..... [2](#)
-



**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
HPA00763DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARF	<a href="#">Samples</a>
TPS3800G27DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARI	<a href="#">Samples</a>
TPS3800G27DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARI	<a href="#">Samples</a>
TPS3801-01DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARF	<a href="#">Samples</a>
TPS3801-01DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARF	<a href="#">Samples</a>
TPS3801E18DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARE	<a href="#">Samples</a>
TPS3801I50DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	NSA	<a href="#">Samples</a>
TPS3801I50DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	NSA	<a href="#">Samples</a>
TPS3801J25DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	NJA	<a href="#">Samples</a>
TPS3801J25DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	NJA	<a href="#">Samples</a>
TPS3801K33DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	NWA	<a href="#">Samples</a>
TPS3801K33DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	NWA	<a href="#">Samples</a>
TPS3801L30DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	NPA	<a href="#">Samples</a>
TPS3801L30DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	NPA	<a href="#">Samples</a>
TPS3801T50DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AVI	<a href="#">Samples</a>
TPS3801T50DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AVI	<a href="#">Samples</a>
TPS3802K33DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARK	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TPS3802L30DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ASA	<a href="#">Samples</a>
TPS3802L30DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ASA	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

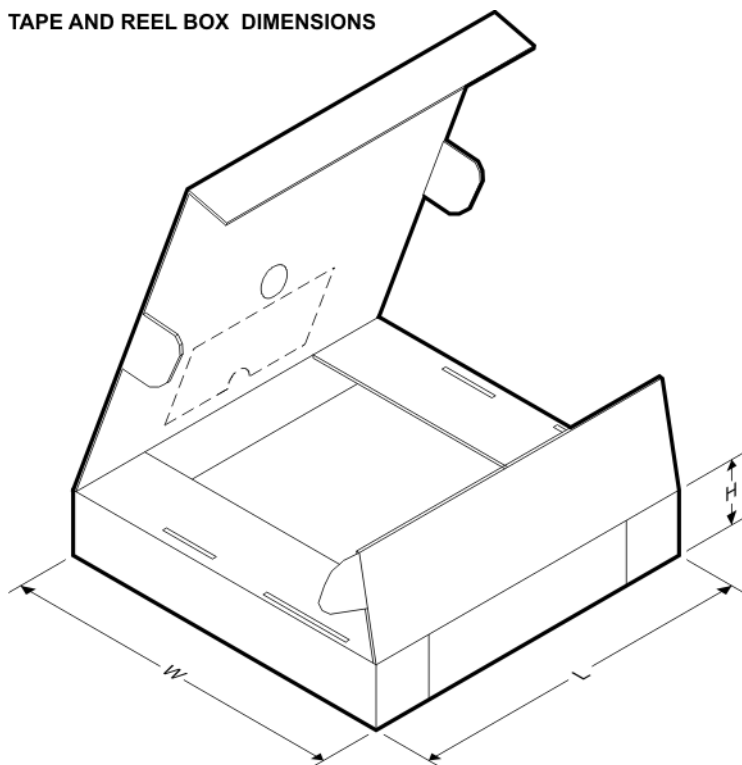


**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS3800G27DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3800G27DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801-01DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801-01DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801E18DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801E18DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801I50DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801J25DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801K33DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801K33DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801L30DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801T50DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801T50DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3802K33DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3802K33DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3802L30DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3802L30DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS3800G27DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3800G27DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801-01DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801-01DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801E18DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801E18DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801I50DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801J25DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801K33DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801K33DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801L30DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801T50DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801T50DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3802K33DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3802K33DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3802L30DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3802L30DCKR	SC70	DCK	5	3000	180.0	180.0	18.0

## DCK (R-PDSO-G5)

## PLASTIC SMALL-OUTLINE PACKAGE



4093553-3/G 01/2007

- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - Falls within JEDEC MO-203 variation AA.

DCK (R-PDSO-G5)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
  - D. Publication IPC-7351 is recommended for alternate designs.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

## IMPORTANT NOTICE

Texas Instruments Incorporated (TI) reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete.

TI's published terms of sale for semiconductor products (<http://www.ti.com/sc/docs/stdterms.htm>) apply to the sale of packaged integrated circuit products that TI has qualified and released to market. Additional terms may apply to the use or sale of other types of TI products and services.

Reproduction of significant portions of TI information in TI data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such reproduced documentation. Information of third parties may be subject to additional restrictions. Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyers and others who are developing systems that incorporate TI products (collectively, "Designers") understand and agree that Designers remain responsible for using their independent analysis, evaluation and judgment in designing their applications and that Designers have full and exclusive responsibility to assure the safety of Designers' applications and compliance of their applications (and of all TI products used in or for Designers' applications) with all applicable regulations, laws and other applicable requirements. Designer represents that, with respect to their applications, Designer has all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. Designer agrees that prior to using or distributing any applications that include TI products, Designer will thoroughly test such applications and the functionality of such TI products as used in such applications.

TI's provision of technical, application or other design advice, quality characterization, reliability data or other services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using TI Resources in any way, Designer (individually or, if Designer is acting on behalf of a company, Designer's company) agrees to use any particular TI Resource solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

Designer is authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY DESIGNER AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

Unless TI has explicitly designated an individual product as meeting the requirements of a particular industry standard (e.g., ISO/TS 16949 and ISO 26262), TI is not responsible for any failure to meet such industry standard requirements.

Where TI specifically promotes products as facilitating functional safety or as compliant with industry functional safety standards, such products are intended to help enable customers to design and create their own applications that meet applicable functional safety standards and requirements. Using products in an application does not by itself establish any safety features in the application. Designers must ensure compliance with safety-related requirements and standards applicable to their applications. Designer may not use any TI products in life-critical medical equipment unless authorized officers of the parties have executed a special contract specifically governing such use. Life-critical medical equipment is medical equipment where failure of such equipment would cause serious bodily injury or death (e.g., life support, pacemakers, defibrillators, heart pumps, neurostimulators, and implantables). Such equipment includes, without limitation, all medical devices identified by the U.S. Food and Drug Administration as Class III devices and equivalent classifications outside the U.S.

TI may expressly designate certain products as completing a particular qualification (e.g., Q100, Military Grade, or Enhanced Product). Designers agree that it has the necessary expertise to select the product with the appropriate qualification designation for their applications and that proper product selection is at Designers' own risk. Designers are solely responsible for compliance with all legal and regulatory requirements in connection with such selection.

Designer will fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of Designer's non-compliance with the terms and provisions of this Notice.